

# ROHID Anti-whisker formation of leadfree plating

#### 1. The Applicable Product

BD33C0AFP-CE2

#### 2. Evaluation Package

No	Item	Information		
1	Subject	LSI product of Leadfree plating		
2	Type of Terminal Plating	Sn		
3	Plating Grain Size	2μm to 10μm		
4	Bath type	Alkyl sulfonic acid, Electro plating		
5	Matt or Bright	Matt		
6	Under Plating	None		
7	Type of Frame	Cu Alloy frame		

#### 3. Compliance standerds

Tin Whisker Acceptance Test Requirements (NEMI Tin Whisker Users Group, July 28, 2004)

### 4. Test Flow

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No	Test Flow	Test Condition			
1	Preparation	MP. condition			
2	Pre Inspection	SEMx250, Top/Side/Forming Section			
3	Preconditioning-1	Storage at ambient temp. for 4 weeks			
4	Preconditioning-2	215°C Reflow, 255°C Reflow			
5	Applying Stress	1. 30°C, 70% RH, 4,000hr			
		2. 60°C, 87% RH, 4,000hr			
		355/+85°C, 2,000cyc			
		4. 30°C, 70%, Bias, 4,000hr			
6	Screening Inspection	x 50, Top/Side/Forming Section			
7	Detailed Inspection	SEMx250, Top/Side/Forming Section			

## 5. Test Result

Criteria: Not allow, the whisker is larger than 40µm between lead to lead.

No	Preconditioning-1	Preconditioning-2	Stress Condition	Result:Pn/n
				(pcs)
1	Storage at ambient temprature. 4 weeks	None	30°C, 70% RH 4,000hr	0/96
2			60°C, 87% RH 4,000hr	0/96
3		215°C Reflow Simulation	30°C, 70% RH 4,000hr	0/96
4			60°C, 87% RH 4,000hr	0/96
5		255°C Reflow Simulation	30°C, 70% RH 4,000hr	0/96
6			60°C, 87% RH 4,000hr	0/96
7		215°C Reflow Simulation	–55/+85°C 2,000cyc	0/96
8		255°C Reflow Simulation	–55/+85°C 2,000cyc	0/96
9		215°C Reflow Assembly	30°C, 70%, Bias 4,000hr	0/96

Therefore, wisker is no problem.

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